

1.1 Scope.

This specification covers the detail requirements for a precision, low input current, low offset voltage, monolithic bipolar amplifier.

1.2 Part Number.

The complete part number per Table 1 of this specification is as follows:

| Device | Part Number |
|--------|-------------|
| -1 | AD705T/883B |

1.2.3 Case Outline.

See Appendix 1 of General Specification ADI-M-1000: package outline:

| (X) | Package | Description |
|-----|---------|----------------------|
| Q | Q-8 | 8-Pin Cerdip Package |

1.3 Absolute Maximum Ratings. ($T_A = +25^\circ\text{C}$ unless otherwise noted)

| | |
|---|---|
| Supply Voltage | $\pm 18\text{ V}$ |
| Internal Power Dissipation ¹ | 650 mW |
| Input Voltage | $\pm V_S$ |
| Differential Input Voltage ² | $\pm 0.7\text{ V}$ |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range | -65°C to $+150^\circ\text{C}$ |
| Operating Temperature Range | -55°C to $+125^\circ\text{C}$ |
| Lead Temperature Range (Soldering 60 sec) | $+300^\circ\text{C}$ |

NOTES

¹Maximum package power dissipation vs. ambient temperature.

| Package Type | MAXIMUM AMBIENT Temperature for Rating | DERATE ABOVE MAXIMUM Ambient Temperature |
|--------------|---|---|
| Q-8 | 75°C | $6.7\text{ mW}/^\circ\text{C}$ |

²The Input pins of this amplifier are protected by back-to-back diodes. If the differential voltage exceeds $\pm 0.7\text{ V}$, external series protection resistors should be added to limit the input current to less than 25 mA.

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| Test | Symbol | Device | Design Limit @ +25°C | Sub Group 1 | Sub Group 2, 3 | Sub Group 4 | Test Condition ¹ | Units |
|-----------------------------------|------------|--------|-------------------------|----------------|-------------------|----------------|---|---------------------------------|
| Input Offset Voltage ² | V_{OS} | -1 | 25 | 90 | 60 | 25 | | $\pm\mu\text{V}$ |
| Input Offset Voltage Drift | TCV_{OS} | -1 | 0.6 | | 0.6 | | | $\pm\mu\text{V}/^\circ\text{C}$ |
| Power Supply Rejection Ratio | PSRR | -1 | 114 | 114 | 108 | | $\pm 2\text{ V} \leq V_S \leq \pm 18\text{ V}$ $\pm 2.5\text{ V} \leq V_S \leq \pm 18\text{ V}$ | $\pm\text{dB}$ |
| Input Bias Current ³ | I_B | -1 | 100 150 | 150 200 | 250 450 | 100 150 | Either Input, $V_{CM} = 0\text{ V}$ Either Input, $V_{CM} = \pm 13.5\text{ V}$ | $\pm\text{pA}$ |
| Input Offset Current | I_{OS} | -1 | 100 150 | 150 200 | 250 450 | 100 150 | $V_{CM} = 0\text{ V}$ $V_{CM} = \pm 13.5\text{ V}$ | $\pm\text{pA}$ |
| Unity Gain Crossover Frequency | F_U | -1 | 0.4 | | | | | MHz |
| Slew Rate | I_{SR} | -1 | 0.1 | | | | | $\text{V}/\mu\text{s}$ |
| Common Mode Rejection Ratio | CMRR | -1 | 114 | 114 | 108 | | $V_{CM} = \pm 13.5\text{ V}$ | dB |
| Open Loop Gain | A_{OL} | -1 | 400 300 | 400 300 | 300 200 | | $V_O = \pm 12\text{ V}, R_L = 10\text{ k}\Omega$ $V_O = \pm 10\text{ V}, R_L = 2\text{ k}\Omega$ | V/mV |
| Output Voltage Swing | V_{OUT} | -1 | ± 13 | ± 13 | ± 13 | | $R_L = 10\text{ k}\Omega$ | V |
| Power Supply Quiescent Current | I_Q | -1 | 600 | 600 | 800 | | | μA |
| Input Noise Voltage | e_N | -1 | 1 | | | | 0.1 to 10 Hz, p-p max | μV |

NOTES

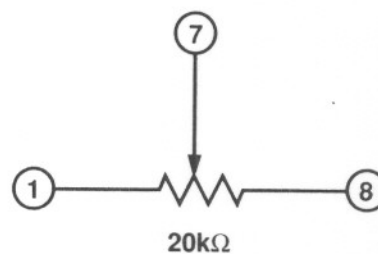
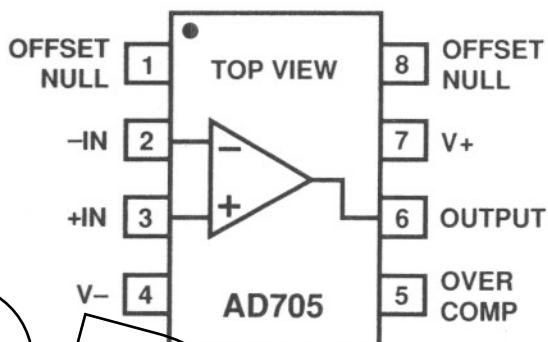
¹ $V_S = \pm 15\text{ V}$ unless otherwise noted.

²Input offset voltage specifications are guaranteed with V_{OS} unnullled at $T_A = +25^\circ\text{C}$.

³Bias current specifications guaranteed maximum at either input.

3.2.1 Functional Block Diagram and Terminal Assignments.

8-Pin Cerdip (Q-8) Package



V_{OS} TRIM

3.2.4 Microcircuit Technology Group.

This microcircuit is covered by technology group (49).

4.2.1 Life Test/Burn-In Circuit.

Steady state life test is per MIL-STD-883 Method 1005. Burn-in is per MIL-STD-883 Method 1015 test condition (B).

